EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|------|--|---|---------------------|---------|---------------------|
| S1 | 14 | (tsukizawa-takayuki).in. | US-PGPUB; USPAT; USOCR; IBM_TDB | OR | ON | 2008/10/16 00:02 |
| S2 | 2 | ("4800459" "5085720").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/04/14 13:59 |
| S3 | 21 | ((tsukizawa-takayuki).in. or (tsukizawa near takayuki).in.) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/04/20 13:42 |
| \$4 | 478 | ((Ikeda-tetsuya).in. or (Ikeda near tetsuya).in.) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/04/20 13:47 |
| S5 | 14 | ((Ikeda-tetsuya).in. or (Ikeda near tetsuya).in.) and (ceramic with (chip or component or IC)) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/04/20 13:48 |
| S6 | 42 | ((chikagawa-osamu).in. or (chikagawa near osamu).in.) and (ceramic with (chip or component or IC)) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/04/20 13:50 |
| S7 | 18 | ((chikagawa-osamu).in. or (chikagawa near osamu).in.) and (ceramic with (chip or component or IC) with electrode) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/04/20 13:50 |
| 58 | 45 | ("4800459").URPN. | USPAT | OR | ON | 2009/04/20 13:55 |
| 39 | 13 | ("2777110" "3699394" "3784878" "4142203" "4225468" "4288841" "4349862" "4451869" "4535350" "4567542" "4585580" "4608592"). PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/04/20 14:02 |
| S10 | 56 | ("5085720").URPN. | USPAT | OR | ON | 2009/04/20 14:03 |
| S11 | 4 | ("3695960" "4753694" "4879156").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/04/20 14:06 |
| 512 | 2 | ("4800459" "5085720").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/05/02 00:03 |
| S13 | 14 | (tsukizawa-takayuki) in or (tsukizawa near takayuki) in . | US-PGPUB; USPAT; USOCR; IBM_TDB | OR | ON | 2009/05/02 00:26 |

| S14 | 21 | (tsukizawa-takayuki).in. or (tsukizawa near takayuki).in. | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/05/02 00:26 |
|-----|-----|---|---|----|-----|---------------------|
| S15 | 26 | (29/832,834,837,854).ccls. and sinter\$3 and (ceramic adj green) and press\$3 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/05/02 00:35 |
| S16 | 17 | ("4299873" "4417297" "4800459" "5045381" "5153987" "5324687" "5401688" "5401913" "5412538" "5481795" "5484647" "5651179" "5652042" "5677045" "5806177" "5888627" "5939782").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/05/02 00:51 |
| S17 | 13 | ("4109296" "4811164" "4899118" "5055966" "5315486" "5384434" "5387888" "5416277" "5708559" "5708570" "5757611" "5814366" "6021050").PN. | US-PGPUB; USPAT; USOCR | OR | ON | 2009/05/02 00:59 |
| S18 | 28 | ("6153290").URPN. | USPAT | OR | ON | 2009/05/02 01:01 |
| S19 | 1 | ("6973707"). <i>P</i> N. | US-PGPUB; USPAT; USOCR; IBM_TDB | OR | OFF | 2009/05/03 21:20 |
| S20 | 7 | (29/830,832,834,837,846,851,854).ccls. and ((ceramic near2 green) with stack\$3) and (chip or component or IC) and electrode and conductor and contact\$3 and ((fir\$3 or heat\$3 or sinter\$3) with press\$3) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/05/05 02:44 |
| S21 | 3 | (174/255,260,261).ccls. and ((ceramic near2 green) with stack\$3) and (chip or component or IC) and electrode and conductor and contact\$3 and ((fir\$3 or heat\$3 or sinter\$3) with press\$3) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/05/05 02:45 |
| S22 | 3 | (257/E21.705,E23.173,E23.009).ccls. and ((ceramic near2 green) with stack\$3) and (chip or component or IC) and electrode and conductor and contact\$3 and ((fir\$3 or heat\$3 or sinter\$3) with press\$3) | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2009/05/05 02:46 |
| S23 | 148 | ((ceramic near2 green) with stack\$3) and (chip or component or IC) and electrode and conductor and contact\$3 and ((fir\$3 or heat\$3 or sinter\$3) with press\$3) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/05/05 02:47 |
| S24 | 13 | ((ceramic near2 green) with stack\$3) same (chip or component or IC) same electrode same conductor and contact\$3 and ((fir\$3 or heat\$3 or sinter\$3) with press\$3) | US-PGPUB; USPAT; USOCR | OR | ON | 2009/05/05 02:49 |

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